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Robert  
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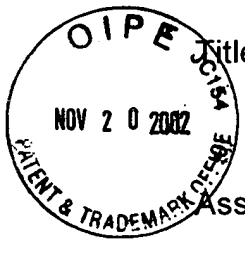
Inventor: Kie Y. Ahn et al.

Title: Methods of Forming Assemblies Comprising Silicon-Doped Aluminum Oxide

Assignee: Micron Technology, Inc.

Serial No.: 09/754,926

Filed: January 4, 2001



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**SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT**

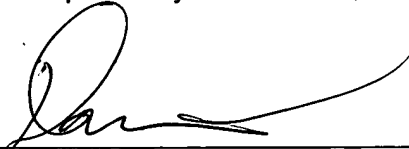
**PURSUANT TO 37 C.F.R. §§ 1.56, 1.97 AND 1.98**

In compliance with 37 C.F.R. §§ 1.56, 1.97 and 1.98, the Examiner's attention is directed to the references listed on the attached Form PTO-1449 and copies of which are attached. No admission is made regarding whether all the submitted references are prior art.

Citation of these references is respectfully requested.

Respectfully submitted,

Date: 11/20/02

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